MOSFETs Silicon N-Channel MOS (DTMOSVI)

TK090A65Z

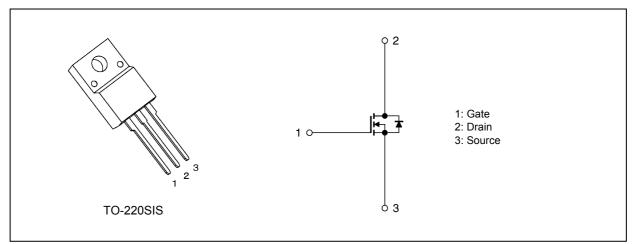
1. Applications

• Switching Power Supplies

2. Features

- (1) Low drain-source on-resistance: $R_{DS(ON)} = 0.075 \Omega$ (typ.)
- (2) High-speed switching properties with lower capacitance.
- (3) Enhancement mode: V_{th} = 3 to 4 V (V_{DS} = 10 V, I_D = 1.27 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (T_a = 25 °C unless otherwise specified)

Characteristics			Rating	Unit
Drain-source voltage		V _{DSS}	650	V
Gate-source voltage		V _{GSS}	±30	1
Drain current (DC)	(Note 1)	Ι _D	30	A
Drain current (pulsed)	(Note 1)	I _{DP}	120	1
Power dissipation (T _c	= 25 °C)	PD	45	W
Single-pulse avalanche energy	(Note 2)	E _{AS}	265	mJ
Single-pulse avalanche current		I _{AS}	7.5	A
Reverse drain current (DC)	(Note 1)	I _{DR}	30]
Reverse drain current (pulsed)	(Note 1)	I _{DRP}	120	
Channel temperature		T _{ch}	150	°C
Storage temperature		T _{stg}	-55 to 150	1
Isolation voltage (RMS)		V _{ISO(RMS)}	2000	V
Mounting torque		TOR	0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production

2019-01

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R _{th(ch-c)}	2.77	°C/W
Channel-to-ambient thermal resistance	R _{th(ch-a)}	62.5	

Note 1: Ensure that the channel temperature does not exceed 150 °C. Note 2: V_{DD} = 90 V, T_{ch} = 25 °C (initial), L = 8.34 mH, I_{AS} = 7.5 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 $^{\circ}$ C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	_	_	±1	μA
Drain cut-off current	I _{DSS}	V_{DS} = 650 V, V_{GS} = 0 V	_	_	2	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	650	—	—	V
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1.27 mA	3	—	4	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 15 A	_	0.075	0.09	Ω

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V_{DS} = 300 V, V_{GS} = 0 V, f = 100 kHz	_	2780	_	pF
Reverse transfer capacitance	C _{rss}			2	_	
Output capacitance	C _{oss}			63	_	1
Effective output capacitance	C _{o(er)}	$V_{DS} = 0$ to 400 V, $V_{GS} = 0$ V		116		pF
Gate resistance	r _g	V _{DS} = OPEN , f = 1 MHz	_	3	_	Ω
Switching time (rise time)	tr	See Figure 6.2.1		30		ns
Switching time (turn-on time)	t _{on}		_	60	_	
Switching time (fall time)	t _f	7		4	_	
Switching time (turn-off time)	t _{off}	7	_	100	_	ns
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} \le V_{(BR)DSS}, I_D \le 15 A$	120		_	V/ns

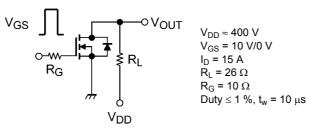


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		47	_	nC
Gate-source charge 1	Q _{gs1}		_	15		
Gate-drain charge	Q _{gd}			12	_	

6.4. Source-Drain Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	V _{DSF}	I _{DR} = 30 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	V _{DD} = 400 V,	_	330	_	ns
Reverse recovery charge	Q _{rr}	I _{DR} = 15 A, V _{GS} = 0 V -dI _{DR} /dt = 100 A/μs	_	5.1		μC
Peak reverse recovery current	l _{rr}		_	31	—	А
Diode dv/dt ruggedness	dv/dt	$V_{DD} \leq 400$ V, $I_{DR} \leq 15$ A, V_{GS} = 0 V	50	_	_	V/ns

7. Marking (Note)

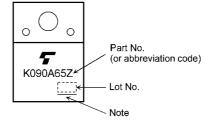
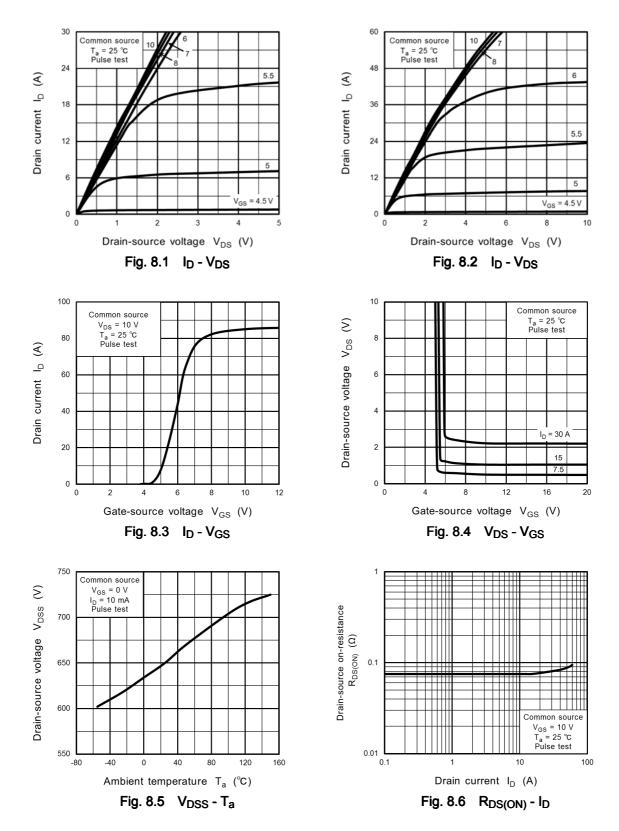


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)





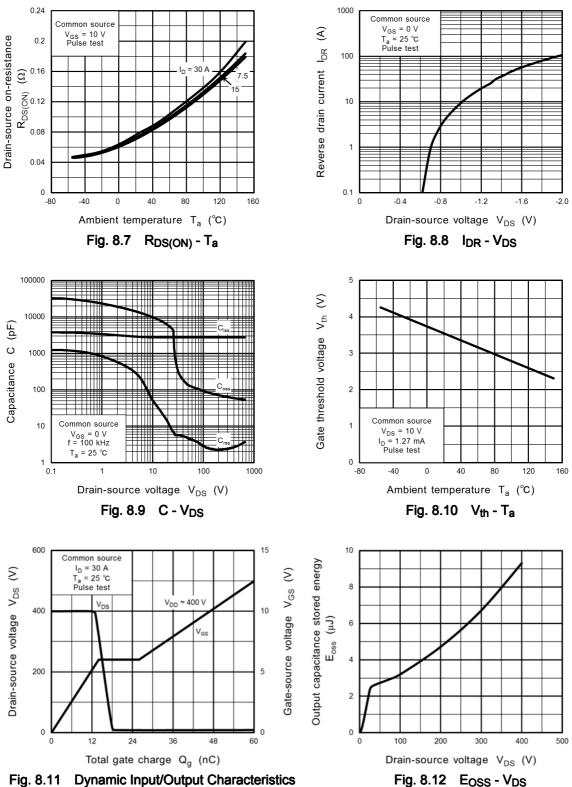
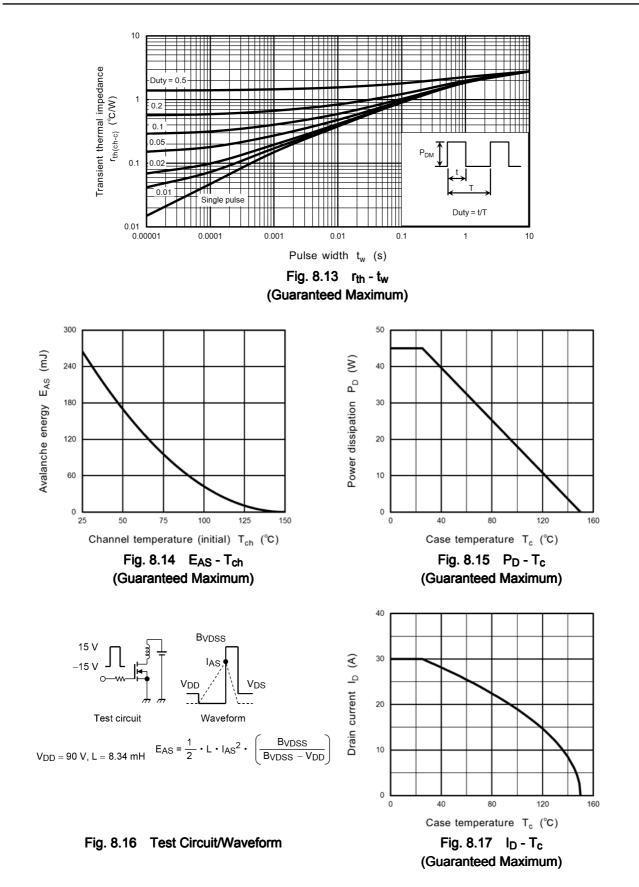
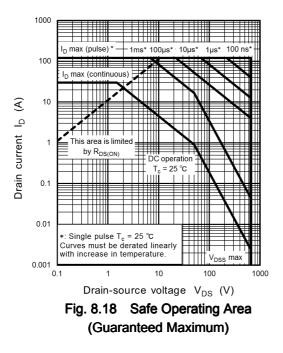


Fig. 8.11 **Dynamic Input/Output Characteristics**



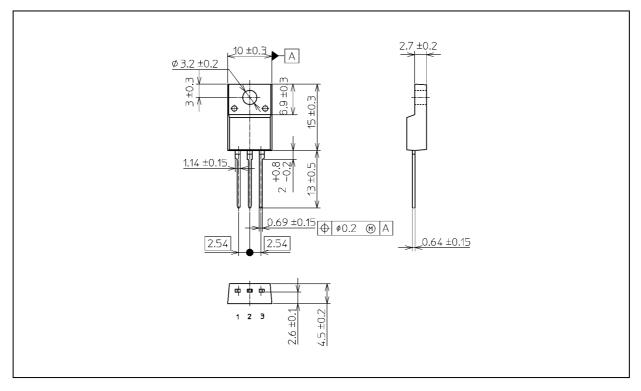


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

TK090A65Z

Package Dimensions

Unit: mm



Weight: 1.7 g (typ.)

Package Name(s)		
JEITA: SC-67		
TOSHIBA: 2-10U1S		
Nickname: TO-220SIS		

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